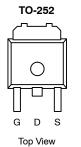


## N-Channel 20-V (D-S)175 °C MOSFET

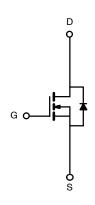
| PRODUCT SUMMARY     |                                 |                                 |  |  |  |
|---------------------|---------------------------------|---------------------------------|--|--|--|
| V <sub>DS</sub> (V) | r <sub>DS(on)</sub> (Ω)         | I <sub>D</sub> (A) <sup>a</sup> |  |  |  |
| 20                  | 0.006 @ V <sub>GS</sub> = 4.5 V | 65                              |  |  |  |
|                     | 0.008 @ V <sub>GS</sub> = 2.5 V | 45                              |  |  |  |

#### FEATURES

- TrenchFET® Power MOSFET
- 175°C Maximum Junction Temperature
- 100% Rg Tested



Drain Connected to Tab



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED) |                                   |                |                     |      |  |  |  |
|---|-----------------------------------|----------------|---------------------|------|--|--|--|
| Parameter   |                                   | Symbol         | Limit               | Unit |  |  |  |
| Drain-Source Voltage  | V <sub>DS</sub>                   | 20             |                     |      |  |  |  |
| Gate-Source Voltage   | V <sub>GS</sub>                   | ±15            | V                   |      |  |  |  |
|   | $T_{C} = 25^{\circ}C$             |                | 65                  |      |  |  |  |
| Continuous Drain Current <sup>a</sup>                                   | $T_{C} = 100^{\circ}C$            | D ID           | 42                  |      |  |  |  |
| Pulsed Drain Current  | I <sub>DM</sub>                   | 200            | - A                 |      |  |  |  |
| Continuous Source Current (Diode Conduction) <sup>a</sup>               | IS                                | 65             |                     |      |  |  |  |
|   | $T_{C} = 25^{\circ}C$             | _              | 71                  |      |  |  |  |
| Maximum Power Dissipation   | $T_A = 25^{\circ}C$               | P <sub>D</sub> | 8.3 <sup>b, c</sup> | w    |  |  |  |
| Operating Junction and Storage Temperature Range                        | T <sub>J</sub> , T <sub>stg</sub> | -55 to 175     | °C                  |      |  |  |  |

| THERMAL RESISTANCE RATINGS               |                   |                   |         |         |      |  |  |
|--|-------------------|-------------------|---------|---------|------|--|--|
| Parameter                                |                   | Symbol            | Typical | Maximum | Unit |  |  |
|  | $t \le 10$ sec.   | R <sub>thJA</sub> | 15      | 18      | °C/W |  |  |
| Maximum Junction-to-Ambient <sup>b</sup> | Steady State      |                   | 40      | 50      |      |  |  |
| Maximum Junction-to-Case                 | R <sub>thJC</sub> | 1.75              | 2.1     |         |      |  |  |

Notes

- a. Package Limited
- b. Surface Mounted on 1" x 1" FR4 Board

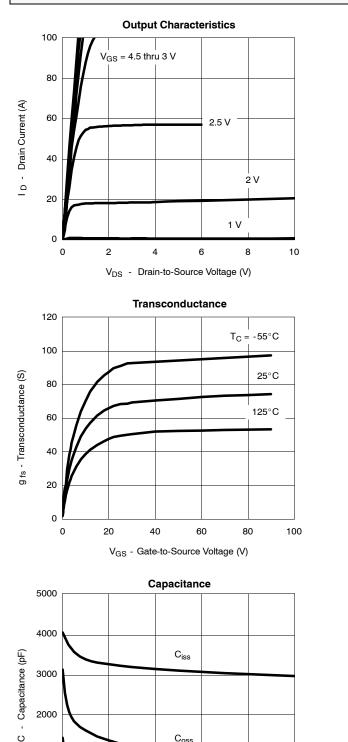
c.  $t \le 10 \text{ sec}$ 

| Parameter                                     | Symbol               | Test Condition  | Min | Тур <sup>а</sup> | Max   | Unit     |
|---|----------------------|---|-----|------------------|-------|----------|
| Static  |                      |   |     |                  |       |          |
| Drain-Source Breakdown Voltage                | V <sub>(BR)DSS</sub> | $V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A                               | 20  |                  |       | v        |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub>  | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$                              | 0.5 |                  | 1.5   |          |
| Gate-Body Leakage                             | I <sub>GSS</sub>     | $V_{DS}$ = 0 V, $V_{GS}$ = ±12 V                                  |     |                  | ±100  | nA       |
|   |                      | V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V                     |     |                  | 1     | <u> </u> |
| Zero Gate Voltage Drain Current               | DSS                  | $V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 $^{\circ}\text{C}$ |     |                  | 50    | μΑ       |
| On-State Drain Current <sup>b</sup>           | I <sub>D(on)</sub>   | $V_{DS}$ = 5 V, $V_{GS}$ = 4.5 V                                  | 65  |                  |       | Α        |
|   |                      | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$            |     | 0.0045           | 0.006 | Ω        |
| Drain-Source On-State Resistance <sup>b</sup> | r <sub>DS(on)</sub>  | $V_{GS}$ = 4.5 V, $I_{D}$ = 20 A, $T_{J}$ = 125 $^{\circ}C$       |     | 0.0055           | 0.007 |          |
|   |                      | $V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$            |     | 0.006            | 0.008 |          |
| Forward Transconductanceb                     | 9fs                  | $V_{DS} = 5 \text{ V}, \text{ I}_{D} = 40 \text{ A}$              | 20  |                  |       | S        |
| Dynamic <sup>a</sup>                          |                      |   |     |                  |       |          |
| Input Capacitance                             | C <sub>iss</sub>     |   |     | 3660             |       |          |
| Output Capacitance                            | C <sub>oss</sub>     | $V_{GS}$ = 0 V, $V_{DS}$ = 20 V, f = 1 MHz                        |     | 730              |       | pF       |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>     |   |     | 375              |       |          |
| Total Gate Charge <sup>c</sup>                | Qg                   |   |     | 26               | 35    | nC       |
| Gate-Source Charge <sup>c</sup>               | Q <sub>gs</sub>      | $V_{DS}$ = 10 V, $~V_{GS}$ = 4.5 V, $I_{D}$ = 40 A                |     | 5                |       |          |
| Gate-Drain Charge <sup>c</sup>                | Q <sub>gd</sub>      |   |     | 7                |       |          |
| Gate Resistance                               | Rg                   |   | 1   |                  | 3.7   | Ω        |
| Turn-On Delay Time <sup>c</sup>               | t <sub>d(on)</sub>   |   |     | 20               | 35    |          |
| Rise Time <sup>c</sup>                        | t <sub>r</sub>       | $V_{DD}$ = 10 V, $R_L$ = 0.25 $\Omega$                            |     | 120              | 190   | ns       |
| Turn-Off Delay Time <sup>c</sup>              | t <sub>d(off)</sub>  | $I_D \cong$ 40 Å, $V_{GEN}$ = 4.5 V, $R_G$ = 2.5 $\Omega$         |     | 45               | 70    |          |
| Fall Time <sup>c</sup>                        | t <sub>f</sub>       |   |     | 20               | 35    |          |
| Source-Drain Diode Ratings an                 | d Characteristi      | c (T <sub>C</sub> = 25°C)   |     |                  |       |          |
| Pulsed Current                                | I <sub>SM</sub>      |   |     |                  | 100   | А        |
| Diode Forward Voltage <sup>b</sup>            | V <sub>SD</sub>      | $I_{F} = 100 \text{ A}, V_{GS} = 0 \text{ V}$                     |     | 1.2              | 1.5   | V        |
| Source-Drain Reverse Recovery Time            | t <sub>rr</sub>      | I <sub>F</sub> = 40 A, di/dt = 100 A/μs                           | 1   | 35               | 70    | ns       |

semi



### **TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**



Coss

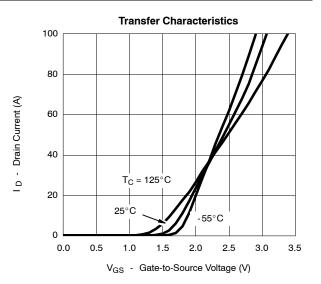
V<sub>DS</sub> - Drain-to-Source Voltage (V)

12

16

20

8

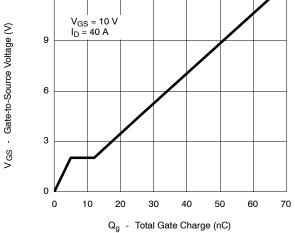


**On-Resistance vs. Drain Current** 0.012  $r_{DS(on)}$  - On-Resistance (  $\Omega$  ) 0.009 V<sub>GS</sub> = 2.5 V 0.006  $V_{GS} = 4.5 V$ 0.003 0.000 0 20 40 60 80 100



12

I<sub>D</sub> - Drain Current (A)



C<sub>rss</sub>

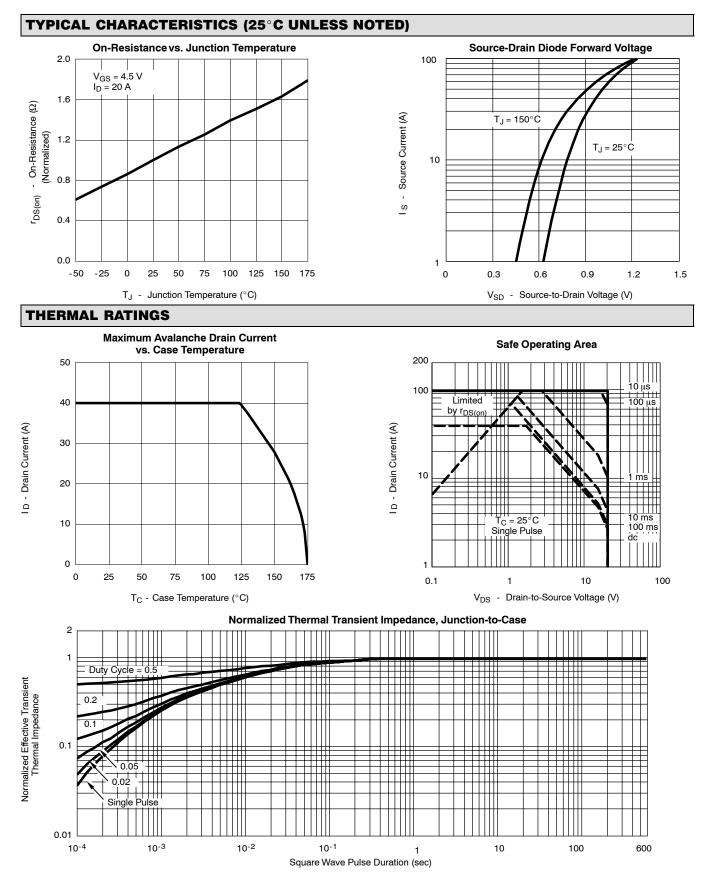
4

2000

1000

0

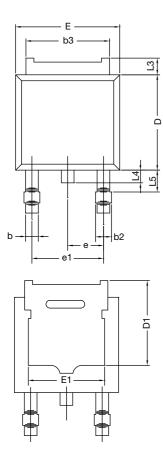
0

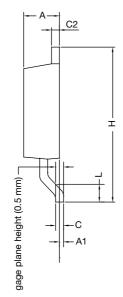






# **TO-252AA CASE OUTLINE**





|  | MILLIMETERS |          | INC       | HES   |  |
|--|-------------|----------|-----------|-------|--|
| DIM.   | MIN.        | MAX.     | MIN.      | MAX.  |  |
| А  | 2.18        | 2.38     | 0.086     | 0.094 |  |
| A1   | -           | 0.127    | -         | 0.005 |  |
| b  | 0.64        | 0.88     | 0.025     | 0.035 |  |
| b2   | 0.76        | 1.14     | 0.030     | 0.045 |  |
| b3   | 4.95        | 5.46     | 0.195     | 0.215 |  |
| С  | 0.46        | 0.61     | 0.018     | 0.024 |  |
| C2   | 0.46        | 0.89     | 0.018     | 0.035 |  |
| D  | 5.97        | 6.22     | 0.235     | 0.245 |  |
| D1   | 5.21        | -        | 0.205     | -     |  |
| E  | 6.35        | 6.73     | 0.250     | 0.265 |  |
| E1   | 4.32        | -        | 0.170     | -     |  |
| Н  | 9.40        | 10.41    | 0.370     | 0.410 |  |
| е  | 2.28        | 2.28 BSC |           | BSC   |  |
| e1   | 4.56 BSC    |          | 0.180 BSC |       |  |
| L  | 1.40        | 1.78     | 0.055     | 0.070 |  |
| L3   | 0.89        | 1.27     | 0.035     | 0.050 |  |
| L4   | -           | 1.02     | -         | 0.040 |  |
| L5   | 1.14        | 1.52     | 0.045     | 0.060 |  |
| ECN: X12-0247-Rev. M, 24-Dec-12<br>DWG: 5347 |             |          |           |       |  |

Note

• Dimension L3 is for reference only.



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